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503.34403VP2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): MASUDA, et al

Serial No.:

(not yet assigned)

Filed:

October 20, 1999

For:

PLASMA ETCHING APPARATUS AND PLASMA ETCHING

METHOD

Group:

Examiner:

UNDER 37 CFR 1.97 & 1.98

Assistant Commissioner for Patents Washington, D.C. 20231

October 20, 1999

sir:

In the matter of the above-identified application, this information disclosure statement is being submitted with the following citation as specified in 37 CFR 1.97(d).

"A copy of any patent, publication or other information listed in an information disclosure statement is not required to be provided if it was previously cited by or submitted to the Office in a prior application, provided that the prior application is properly identified in the statement and relied upon for an earlier filing date under 35 U.S.C. 120."

Applicant(s) are submitting herewith a copy of Form PTO-1449 which list documents cited in parent application(s)

Serial No. 09/227,332, which is a Continuation-in-Part of

Serial No. 08/611,758, now U.S. Patent No. 5,874,012.

It is respectfully requested that this information disclosure statement be considered by the Examiner.

Please charge any shortage in the fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account No. 01-2135 (503.34403VP2) and please credit any excess fees to such deposit account.

Respectfully submitted,

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